

BB207

FM variable capacitance double diode

Rev. 3 — 7 September 2011

Product data sheet

1. Product profile

1.1 General description

The BB207 is a variable capacitance double diode with a common cathode, fabricated in silicon planar technology, and encapsulated in the SOT23 small plastic SMD package.

1.2 Features and benefits

- Excellent linearity
- C_{d(1V)}: 81 pF; C_{d(7.5V)}: 27.6 pF
- lacksquare $C_{d(1V)}$ to $C_{d(7.5V)}$ ratio: min. 2.6
- Very low series resistance
- Small plastic SMD package.

1.3 Applications

Electronic tuning in FM-radio.

2. Pinning information

Table 1. Discrete pinning

Pin	Description	Simplified outline	Symbol		
1	anode 1	-	_		
2	anode 2	3	3		
3	common cathode	12	1 2		
			sym032		

3. Ordering information

Table 2. Ordering information

Type number	Package		
	Name	Description	Version
BB207	-	plastic surface mounted package; 3 leads	SOT23



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4. Marking

Table 3. Marking

Type number	Marking code ^[1]
BB207	*13

^{[1] * =} p: made in Hong Kong.

5. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
Per diode					
V _R	continuous reverse voltage		-	15	V
I _F	continuous forward current		-	20	mA
T _{stg}	storage temperature		-55	+150	°C
Tj	junction temperature		– 55	+125	°C

6. Characteristics

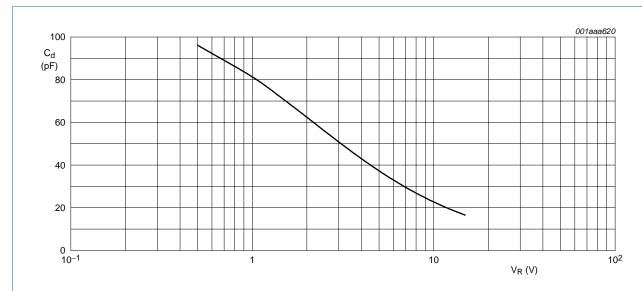
Table 5. Electrical Characteristics

 $T_i = 25$ °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per diode						
I _R	reverse current	V _R = 15 V; see <u>Figure 2</u>	-	_	10	nA
		$V_R = 15 \text{ V}; T_j = 85 ^{\circ}\text{C}; \text{ see } \frac{\text{Figure 2}}{}$	-	_	200	nA
r _s	diode series resistance	$f = 100 \text{ MHz}; V_R = 3 \text{ V}$	-	0.2	0.4	Ω
C _d	diode capacitance	V _R = 1 V; f = 1 MHz; see Figure 1	76	81	86	pF
		V _R = 3 V; f = 1 MHz; see Figure 1	_	50.5	_	pF
		V _R = 7.5 V; f = 1 MHz; see <u>Figure 1</u>	25.5	27.6	29.7	pF
		V _R = 8 V; f = 1 MHz; see <u>Figure 1</u>	-	26.3	_	pF
$\frac{C_{d(1V)}}{C_{d(7.5V)}}$	capacitance ratio	f = 1 MHz	2.6	-	3.3	

^{* =} w: made in China.

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 $f = 1 \text{ MHz}; T_j = 25 \text{ }^{\circ}\text{C}.$

Fig 1. Diode capacitance as a function of reverse voltage; typical values.

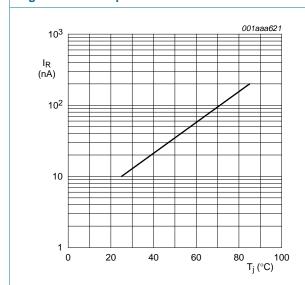


Fig 2. Reverse current as a function of junction temperature; maximum values.

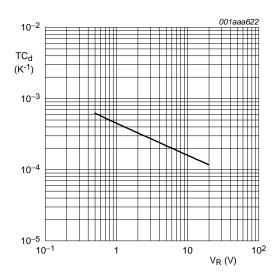


Fig 3. Temperature coefficient of diode capacitance as a function of reverse voltage; typical values.

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7. Package outline

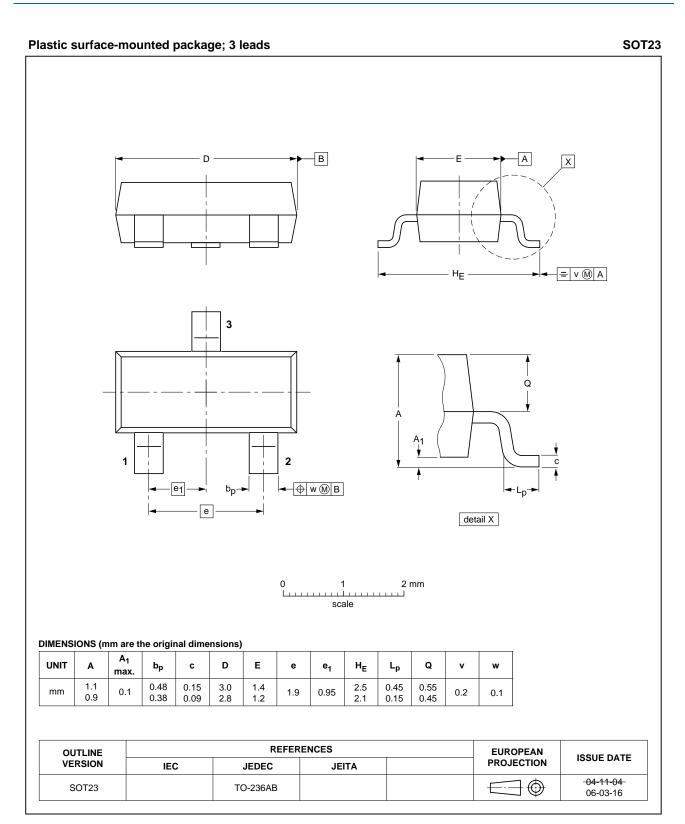


Fig 4. Package outline.

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8. Revision history

Table 6. Revision history

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Document ID	Release date	Data sheet status	Change notice	Supersedes
BB207 v.3	20110907	Product data sheet	-	BB207 v.2
Modifications:	guidelines o	of this data sheet has been of NXP Semiconductors. have been adapted to the n		•
 Package outline drawings have been updated to the latest version. 				
BB207 v.2 (9397 750 13003)	20040427	Product data	-	BB207_N v.1
BB207_N v.1 (9397 750 12695)	20031117	Preliminary data	-	-

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9. Legal information

9.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
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Date of release: 7 September 2011

Document identifier: BB207